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### **ON Semiconductor**®

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#### P-Channel Power Trench<sup>®</sup> MOSFET -80 V, -2.1 A, 183 m $\Omega$

#### Features

- Max  $r_{DS(on)}$  = 183 m $\Omega$  at V<sub>GS</sub> = -10 V, I<sub>D</sub> = -2.1 A
- Max  $r_{DS(on)}$  = 233 m $\Omega$  at V<sub>GS</sub> = -4.5 V, I<sub>D</sub> = -1.9 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
   High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

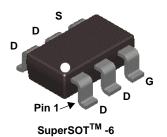


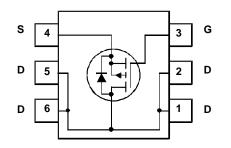
#### **General Description**

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process that has been optimized for  $r_{DS(on)}$ , switching performance and ruggedness.

#### Applications

- Load Switch
- Synchronous Rectifier





#### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		-80	V
V <sub>GS</sub>	Gate to Source Voltage		±20	V
-	Drain Current -Continuous	(Note 1a)	-2.1	•
D	-Pulsed		-10	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	37	mJ
P <sub>D</sub>	Power Dissipation	(Note 1a)	1.6	W
	Power Dissipation	(Note 1b)	0.7	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	30	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 78	C/W

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
.535	FDC3535	SSOT-6	7 "	8 mm	3000 units	

April 2015

Тур	Max	Units
		V
-64		mV/°C
	-1	μA
	±100	nA
-1.6	-3	V
-1.6	-3	V
5		mV/°C
147	183	
176	233	mΩ
246	307	
6.3		S
659	880	pF
000		

FDC3535 P-Channel Power Trench<sup>®</sup> MOSFET

## g<sub>FS</sub> Forward Transconductance Dvnamic Characteristics

Symbol

BV<sub>DSS</sub>

 $\Delta T_{J}$ 

IDSS

I<sub>GSS</sub>

V<sub>GS(th)</sub>

 $\Delta T_{J}$ 

r<sub>DS(on)</sub>

 $\Delta V_{GS(th)}$ 

 $\Delta BV_{DSS}$ 

**Off Characteristics** 

**On Characteristics** 

Coefficient

**Electrical Characteristics**  $T_J = 25$  °C unless otherwise noted

Parameter

Drain to Source Breakdown Voltage

Breakdown Voltage Temperature

Zero Gate Voltage Drain Current

Gate to Source Leakage Current

Gate to Source Threshold Voltage

Gate to Source Threshold Voltage

Static Drain to Source On Resistance

**Temperature Coefficient** 

-,					
C <sub>iss</sub>	Input Capacitance		659	880	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz	49	65	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		24	40	pF
Rg	Gate Resistance		5.7		Ω

**Test Conditions** 

 $I_D = -250 \ \mu A$ , referenced to 25 °C

 $I_D = -250 \ \mu A$ , referenced to 25 °C

V<sub>GS</sub> = -10 V, I<sub>D</sub> = -2.1 A, T<sub>J</sub> = 125 °C

 $I_D = -250 \ \mu A, \ V_{GS} = 0 \ V$ 

 $V_{DS} = -64 \text{ V}, V_{GS} = 0 \text{ V}$ 

 $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ 

 $V_{GS} = V_{DS}, I_D = -250 \ \mu A$ 

 $V_{GS} = -10 \text{ V}, I_D = -2.1 \text{ A}$  $V_{GS} = -4.5 \text{ V}, I_D = -1.9 \text{ A}$ 

V<sub>DD</sub> = -10 V, I<sub>D</sub> = -2.1 A

Min

-80

-1

#### **Switching Characteristics**

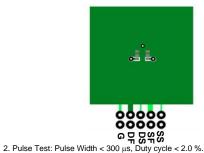
t <sub>d(on)</sub>	Turn-On Delay Time		6.5	13	ns
t <sub>r</sub>	Rise Time	$V_{DD} = -40 \text{ V}, \text{ I}_{D} = -2.1 \text{ A},$	3.1	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	23	38	ns
t <sub>f</sub>	Fall Time		2.9	10	ns
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } -10 V$	14	20	nC
	Total Gate Charge	$V_{GS} = 0 V \text{ to } -4.5 V V_{DD} = -40 V$	6.8	10	nC
Q <sub>gs</sub>	Total Gate Charge	I <sub>D</sub> = -2.1 A	1.6		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		2.7		nC

#### **Drain-Source Diode Characteristics**

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -2.1 A$	(Note 2)	-0.81	-1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = -2.1 A, di/dt = 100 A/μs		25	40	ns
Q <sub>rr</sub>	Reverse Recovery Charge			23	38	nC

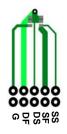
NOTES:

1. R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>BJC</sub> is guaranteed by design while R<sub>BCA</sub> is determined by the user's board design.



3. Starting  $T_J$  = 25 °C, L = 3 mH,  $I_{AS}$  = -5 A,  $V_{DD}$  = -80 V,  $V_{GS}$  = -10 V.

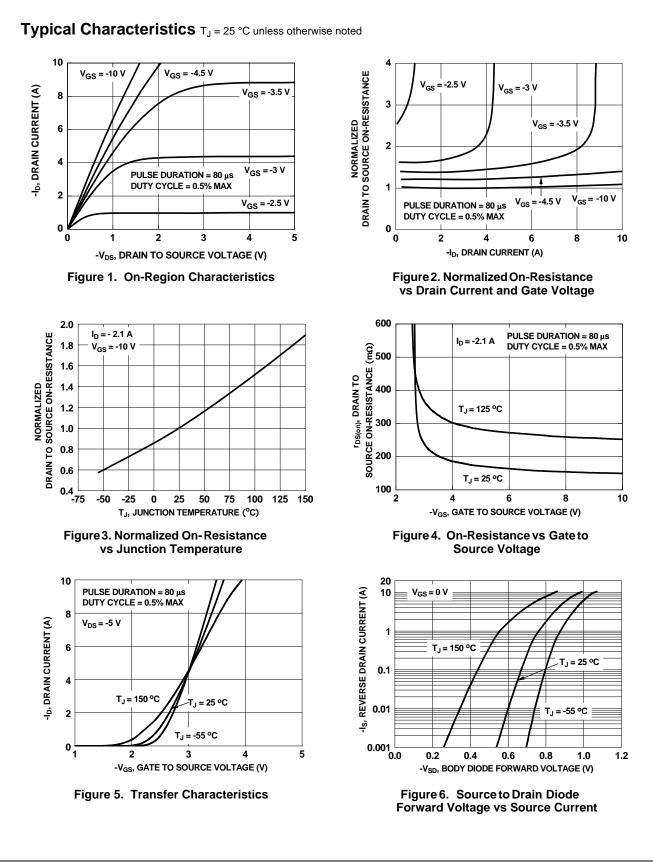
a. 78 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



b.175 °C/W when mounted on a minimum pad of 2 oz copper

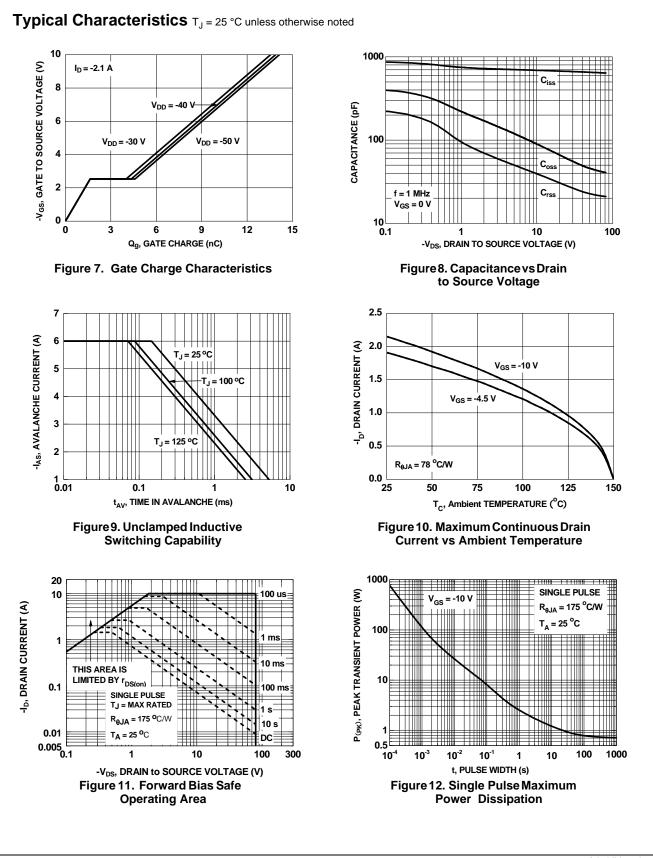
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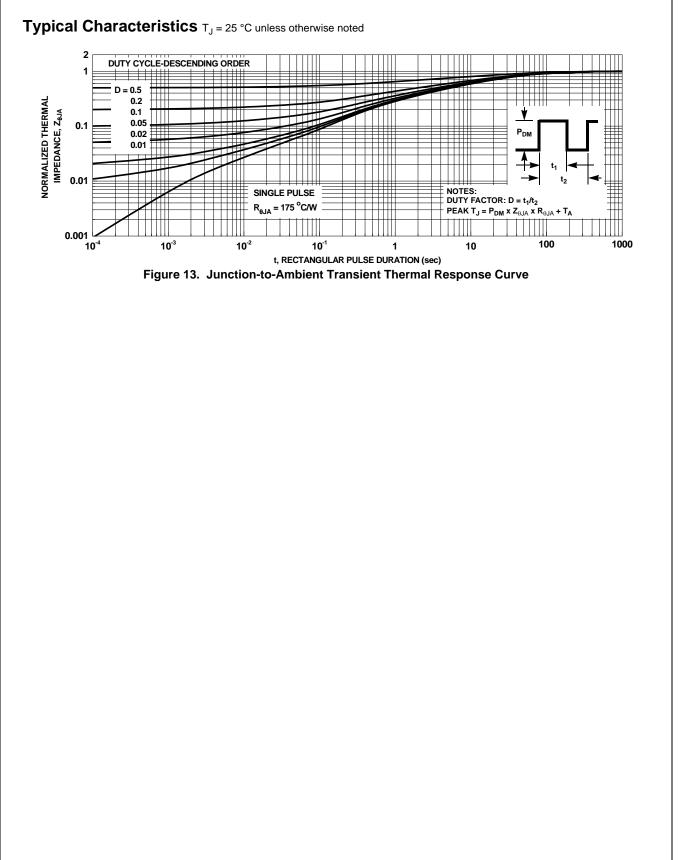


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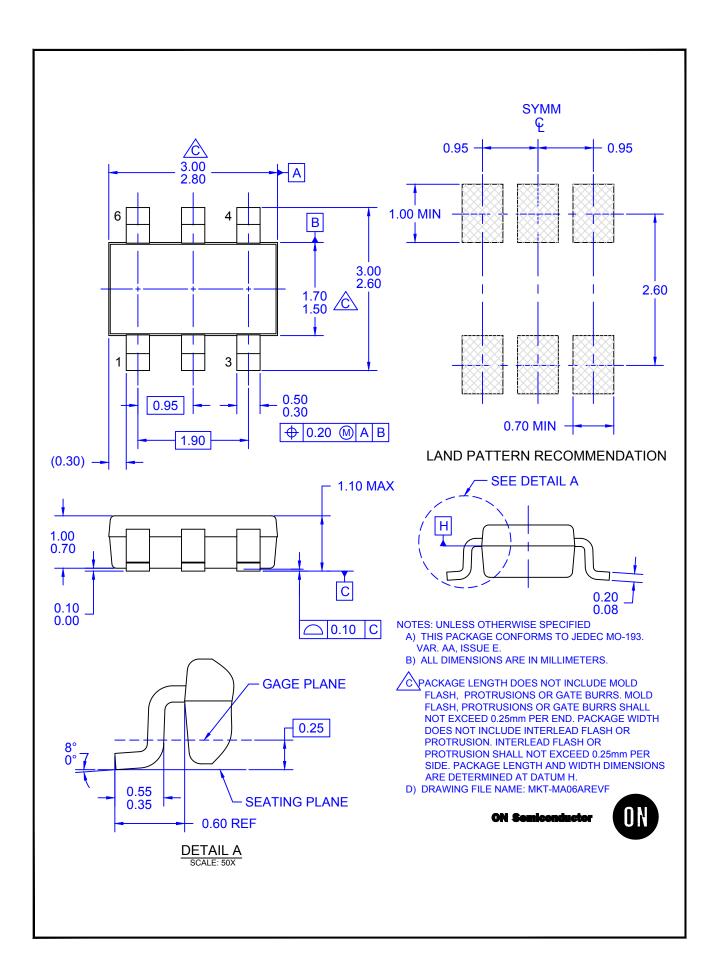
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